

## Declaration for U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention **entitled** PROCESS FOR PRODUCING BARRIER FILM AND BARRIER FILM THUS PRODUCED  
the specification of which is attached hereto unless the following is checked



was filed on \_\_\_\_\_ as United States Application Number or PCT International Application Number \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed:

(List Prior foreign applications.				Priority Claimed
	<u>Hei 11-38041</u> (Number)	<u>Japan</u> (Country)	<u>17/2/1999</u> (Day/Month/Year Filed)	<u>X</u> Yes ___ No
	<u>Hei 11-192026</u> (Number)	<u>Japan</u> (Country)	<u>6/7/1999</u> (Day/Month/Year Filed)	<u>X</u> Yes ___ No
	_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	___ Yes ___ No
	_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	___ Yes ___ No

\_\_\_\_ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List Prior U.S. Applications)	(Appln. Serial Number)	(Filing Date)	(Status Patented, Pending, Abandoned)
	_____ (Appln. Serial Number)	_____ (Filing Date)	_____ (Status: Patented, Pending, Abandoned)
	_____ (Appln. Serial Number)	_____ (Filing Date)	_____ (Status: Patented, Pending, Abandoned)

I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

James E. Armstrong, III, Reg. No. 18,366, William F. Westerman, Reg. No. 29,988, Ken-Ichi Hattori, Reg. No. 32,861, Le-Nhung McLeland, Reg. No. 31,541, Ronald F. Naughton, Reg. No. 24,616, William G. Kratz, Jr., Reg. No. 22,631, Mel R. Quintos, Reg. No. 31,898, James P. Welch, Reg. No. 17,379, John R. Pegan, Reg. No. 18,069, Donald W. Hanson, Reg. No. 27,133, Stephen G. Adrian, Reg. No. 32,878, William L. Brooks, Reg. No. 34,129, John F. Carney, Reg. No. 20,276, Edward F. Welsh, Reg. No. 22,455, Patrick D. Muir, Reg. No. 37,403, Gay A. Spahn, Reg. No. 34,978, John P. Kong, Reg. No. 40,054, and Luke A. Kilyk, Reg. No. 33,251, Leonard D. Bowersox, Reg. No. 33,226.

Please direct all communications to the following address:

**ARMSTRONG, WESTERMAN, HATTORI,  
McLELAND & NAUGHTON**  
1725 K Street, N.W., Suite 1000  
Washington, D.C. 20006  
Telephone (202)659-2930 Fax:(202)887-0357

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole inventor (given name, family name) MASAMICHI HARADA  
Inventor's signature Masamichi Harada Date January 31, 2000  
Residence c/o NIHON SHIMKU GIJUSTU KABUSHIKI KAISHA 2500, Hagisono  
Chigasaki-shi Kanagawa 253-8543 Japan Citizenship Japanese  
Post Office Address same as the above

Full name of second inventor (given name, family name) \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship Japanese  
Post Office Address same as the above

Full name of third inventor (given name, family name) \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship Japanese  
Post Office Address same as the above

Full name of forth inventor (given name, family name) \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship Japanese  
Post Office Address \_\_\_\_\_

Full name of fifth inventor (given name, family name) \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship Japanese  
Post Office Address \_\_\_\_\_